



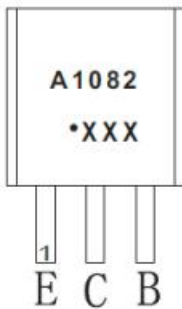
TO-92 Plastic-Encapsulate Transistors

2SA1082 TRANSISTOR (NPN)

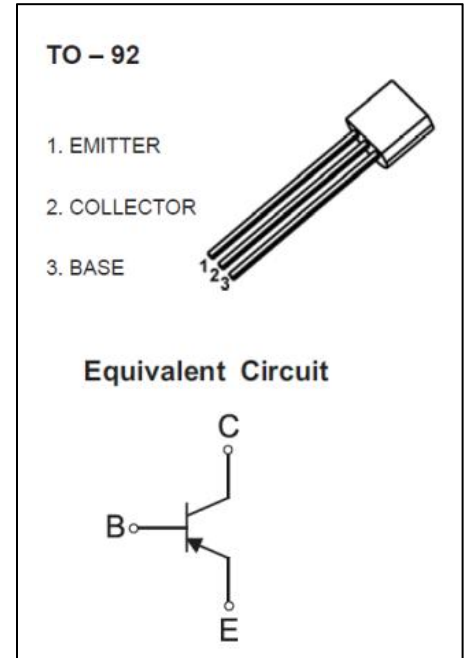
FEATURES

- Low Frequency Amplifier
- AEC Q101 Qualified

MARKING



A1082=Device code
 Solid dot=Green molding compound device,
 if none,the normal device
 XXX=Code



ORDERING INFORMATION

Part Number	Package	Packing Method	Pack Quantity
2SA1082	TO-92	Bulk	1000pcs/Bag
2SA1082-TA	TO-92	Tape	2000pcs/Box

MAXIMUM RATINGS ($T_a=25C$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	-120	V
V_{CEO}	Collector-Emitter Voltage	-120	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current	-0.1	A
P_C	Collector Power Dissipation	480	mW
R_{OJA}	Thermal Resistance From Junction To Ambient	312	$^{\circ}C/W$
T_J, T_{stg}	Operation Junction and Storage Temperature Range	-55~+175	$^{\circ}C$

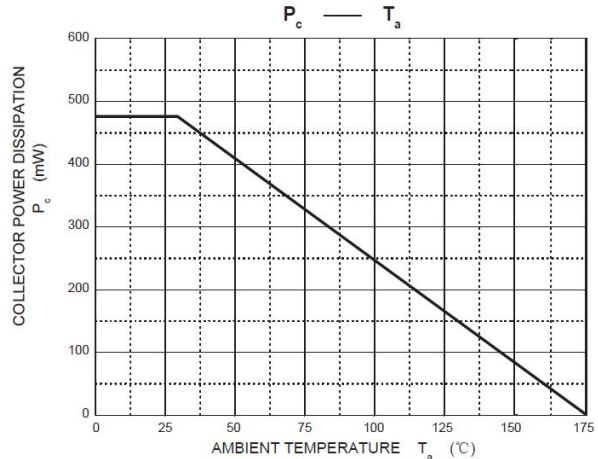
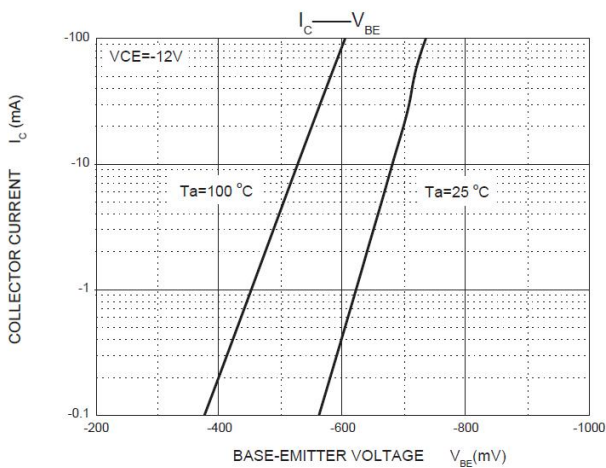
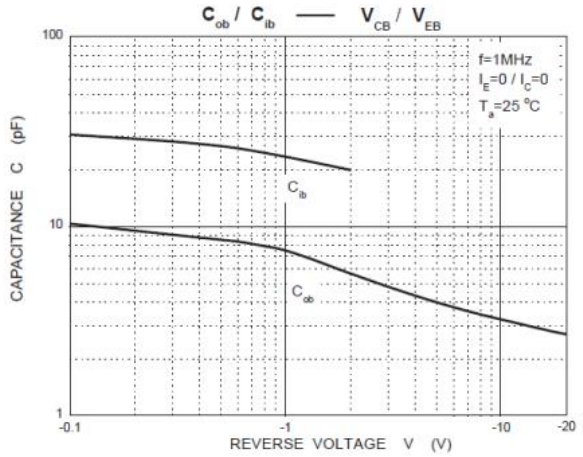
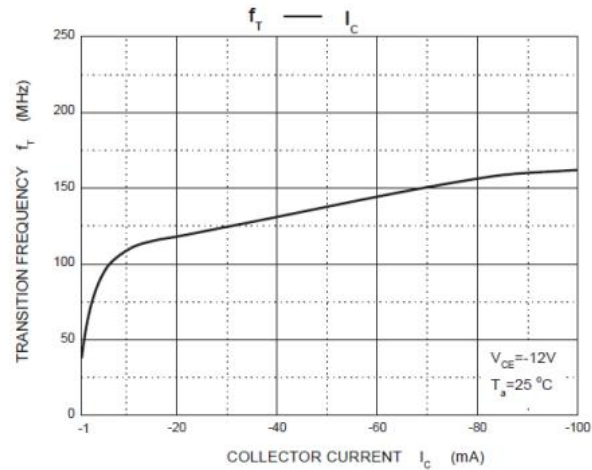
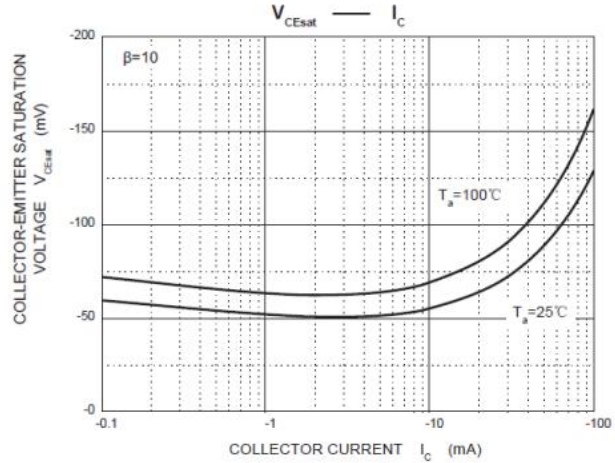
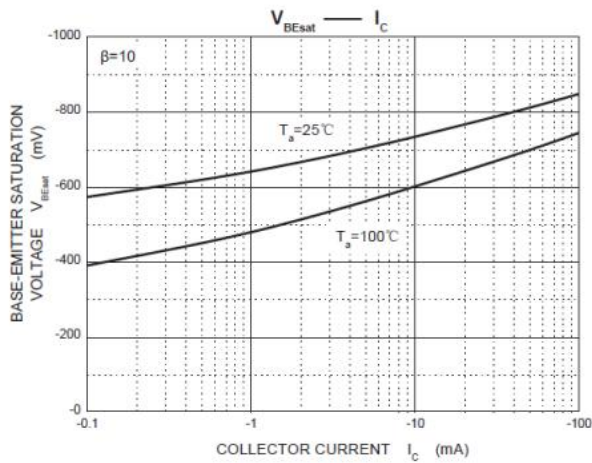
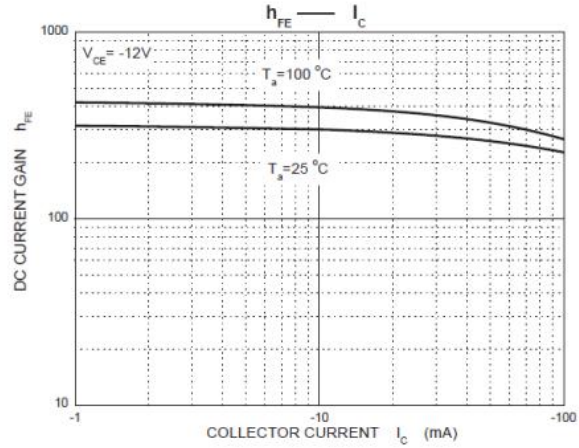
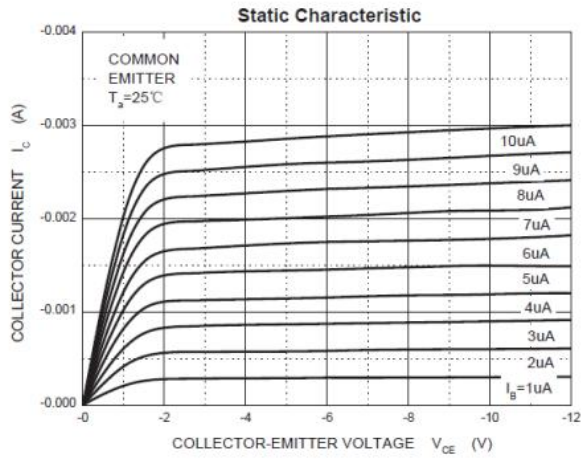
ELECTRICAL CHARACTERISTICS ($T_a=25\text{ C}$ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=-0.01\text{mA}, I_E=0$	-120			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=-1\text{mA}, I_B=0$	-120			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=-0.01\text{mA}, I_C=0$	-5			V
Collector cut-off current	I_{CBO}	$V_{CB}=-50\text{V}, I_E=0$			-0.1	KA
Emitter cut-off current	I_{EBO}	$V_{EB}=-2\text{V}, I_C=0$			-0.1	KA
DC current gain	h_{FE}	$V_{CE}=-12\text{V}, I_C=-2\text{mA}$	250		800	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=-10\text{mA}, I_B=-1\text{mA}$			-0.2	V
Base-emitter voltage	V_{BE}	$V_{CE}=-12\text{V}, I_C=-2\text{mA}$		-0.6		V
Collector output capacitance	C_{ob}	$V_{CB}=-10\text{V}, I_E=0, f=1\text{MHz}$		3.5		pF
Transition frequency	f_T	$V_{CE}=-12\text{V}, I_C=-2\text{mA}$		90		MHz

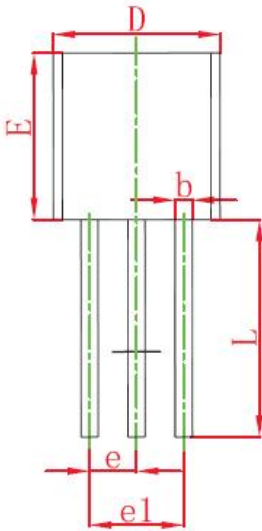
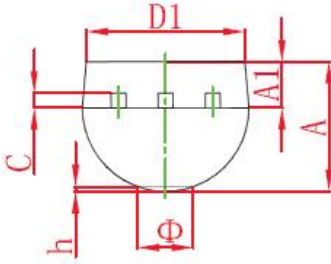
CLASSIFICATION OF h_{FE}

RANK	D	E
RANGE	250-500	400-800

Typical Characteristics

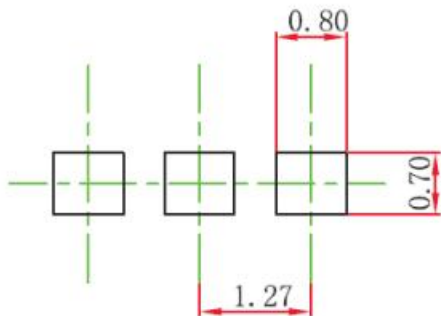


TO-29 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	3.300	3.700	0.130	0.146
A1	1.100	1.400	0.043	0.055
b	0.380	0.550	0.015	0.022
c	0.360	0.510	0.014	0.020
D	4.300	4.700	0.169	0.185
D1	3.430		0.135	
E	4.300	4.700	0.169	0.185
e	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	14.100	14.500	0.555	0.571
v		1.600		0.063
h	0.000	0.380	0.000	0.015

TO-29 Suggested Pad Layout



Note:

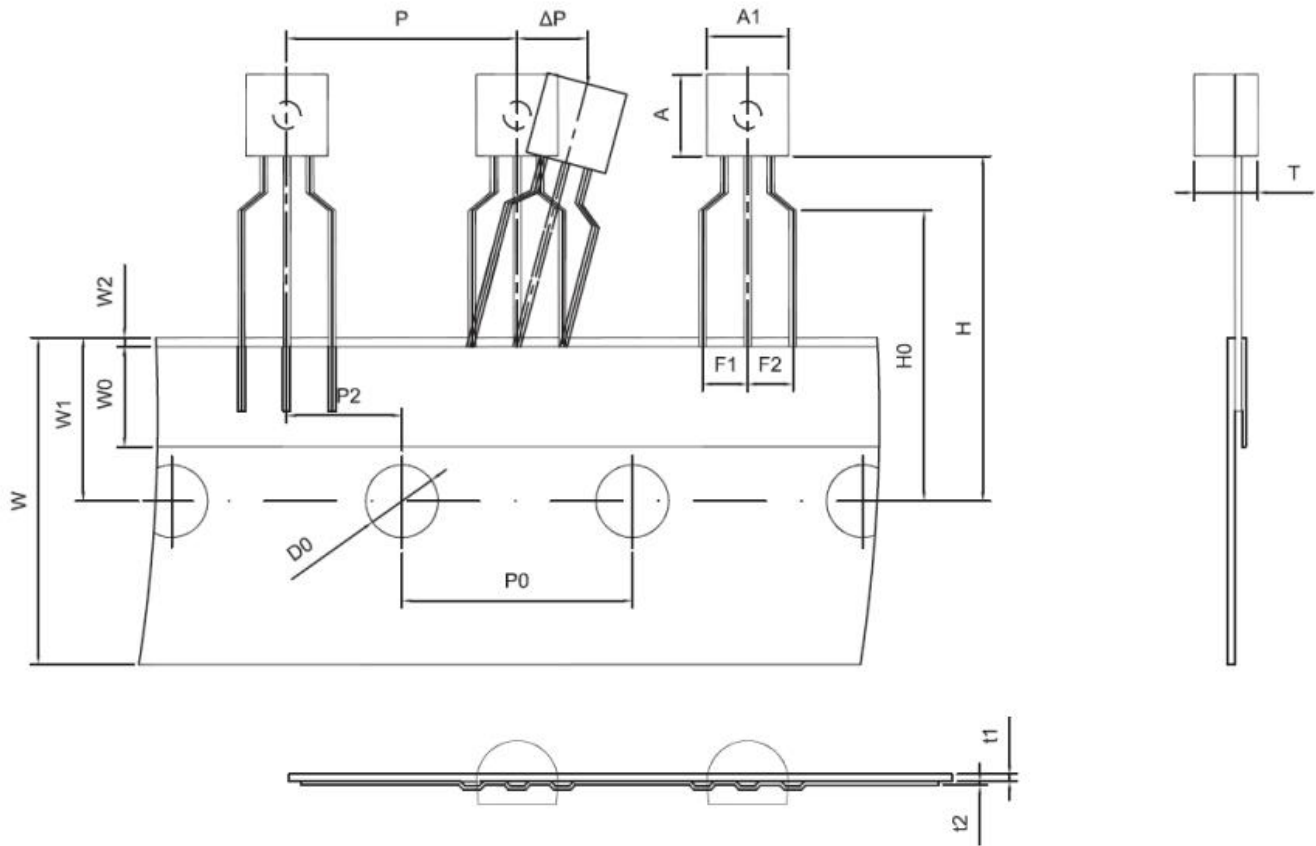
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

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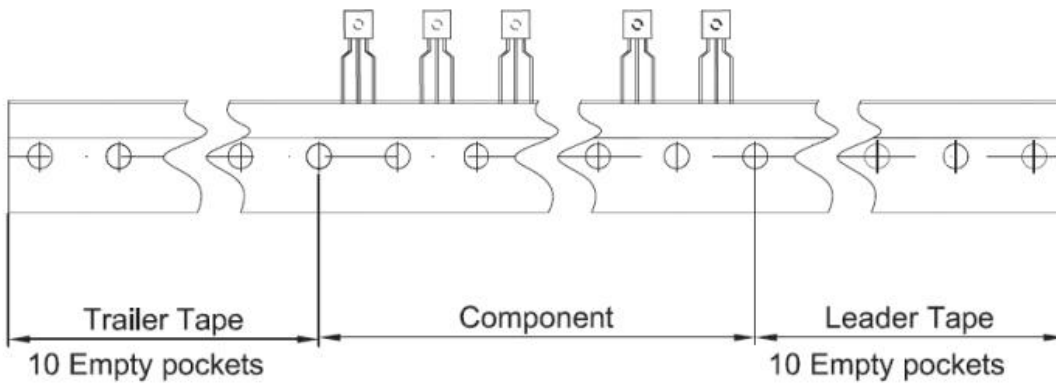
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TO-29 Tape and Reel



Dimiensions are in millimeter

A1	A	T	P	P0	P2	F1	F2	W
4.5	4.5	3.5	12.7	12.7	6.35	2.5	2.5	18.0
W0	W1	W2	H	H0	D0	t1	t2	ΔP
6.0	9.0	1.0 MAX.	19.0	16.0	4.0	0.4	0.2	0



Package	Box	Box Size(mm)	Carton	Carton Size(mm)
TO-92	2000 pcs	333×162×43	20,000 pcs	350×340×250

Date of change	Rev #	revise content
2023/06/06	A/0	/